## Nanocomposites and nanomaterials

## Bimetallic Ag<sub>x</sub>Cu<sub>y</sub> nanoparticles stabilized by polybutylmethacrylate as the fillers for electroconductive compositions

## L.I. Bazylyak

Department of Physical Chemistry of Fossil Fuels, Institute of Physical Organic Chemistry and Coal Chemistry named after L. M. Lytvynenko National Academy of Sciences of Ukraine. 3a Naukova Str., Lviv-53, 79053, Ukraine. E-mail: bazyljak.L.I@nas.gov.ua

It is proposed a method for the synthesis of bimetallic nanoparticles Ag<sub>x</sub>Cu<sub>y</sub> with simultaneous stabilization of their surface by polybutylmethacrylate under conditions of heterogeneous nucleation. The shape and the size of synthesized nanoparticles  $Ag_{\chi}Cu_{\chi}$  were investigated by the method of electron microscopy. It was established that all obtained bimetallic nanoparticles are spherical shape with an average diameter of  $70 \pm 30$  nm. With the use of X-ray diffraction analysis it was investigated the phase composition of obtained bimetallic nanoparticles Ag<sub>x</sub>Cu<sub>y</sub> and it was determined that their elemental composition is satisfactorily agreed with the original ratio of the components. At the same time, it was shown that the stability to oxidation of synthesized bimetallic nanoparticles increases with the increasing of silver content in them, which may indicate the formation of eutectic mixtures of silver and copper. Based on the data of energy dispersive spectroscopy and IR spectroscopy of obtained products it was proposed the scheme of the formation of stabilizing shell on the surface of bimetallic nanoparticles Ag<sub>x</sub>Cu<sub>y</sub>, which includes the initiation process by hydrazyl-radical and following polymerization of butylmethacrylate from the surface of the particle. It was shown the possibility of the use of synthesized nanoparticles Ag<sub>x</sub>Cu<sub>y</sub> as the fillers for electroconductive polymeric compositions, the high electrical conductivity of which is provided by the formation of chains involving the nanoparticles Ag<sub>3</sub>Cu.